







#### **IF3601 N-Channel JFET**

#### **Features**

InterFET N3600L Geometry

Ultra Low Noise: 0.5 nV/VHz Typical

High Gain: 750mS TypicalLow Rds(on): 2.0 Ohms Typical

RoHS Compliant

• SMT, TH, and Bare Die Package options.

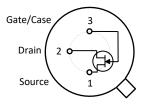
#### **Applications**

· Low-Noise, High Gain Amplifiers

#### Description

The -20V InterFET IF3601 JFET is targeted for ultra low noise high gain amplifier designs. The IF3601 has a cutoff voltage of less than 2.0V ideal for low voltage applications. The TO-39 package is hermetically sealed and suitable for military applications.

#### **TO-39 Bottom View**





**Product Summary** 

| Parameters           |                                    | IFN3601 Min | Unit |  |
|----------------------|------------------------------------|-------------|------|--|
| BV <sub>GSS</sub>    | Gate to Source Breakdown Voltage   | -20         | V    |  |
| I <sub>DSS</sub>     | Drain to Source Saturation Current | 30          | mA   |  |
| V <sub>GS(off)</sub> | Gate to Source Cutoff Voltage      | -0.35       | V    |  |
| GFS                  | Forward Transconductance           | 750 Typical | mS   |  |

Ordering Information Custom Part and Binning Options Available

| Part Number | Description                            | Case  | Packaging       |
|-------------|--|-------|-----------------|
| IF3601T39   | Through-Hole                           | TO-39 | Bulk            |
| IF3601COT   | Chip Orientated Tray (COT Waffle Pack) | COT   | 100/Waffle Pack |
| IF3601CFT   | Chip Face-up Tray (CFT Waffle Pack)    | CFT   | 100/Waffle Pack |



**Disclaimer:** It is the Buyers responsibility for designing, validating and testing the end application under all field use cases and extreme use conditions. Guaranteeing the application meets required standards, regulatory compliance, and all safety and security requirements is the responsibility of the Buyer. These resources are subject to change without notice.









## **Electrical Characteristics**

Maximum Ratings (@ T<sub>A</sub> = 25°C, Unless otherwise specified)

|                  | Parameters                                 | Value      | Unit  |
|------------------|--|------------|-------|
| $V_{RGS}$        | Reverse Gate Source and Gate Drain Voltage | -20        | V     |
| I <sub>FG</sub>  | Continuous Forward Gate Current            | 10         | mA    |
| PD               | Continuous Device Power Dissipation        | 300        | mW    |
| Р                | Power Derating                             | 2          | mW/°C |
| Τı               | Operating Junction Temperature             | -55 to 125 | °C    |
| T <sub>STG</sub> | Storage Temperature                        | -65 to 200 | °C    |

Static Characteristics (@ TA = 25°C, Unless otherwise specified)

|                      | Parameters                            | Conditions                                    | Min   | Тур | Max  | Unit |
|----------------------|---------------------------------------|---|-------|-----|------|------|
| V <sub>(BR)GSS</sub> | Gate to Source<br>Breakdown Voltage   | $V_{DS} = 0V$ , $I_{G} = -1\mu A$             | -20   |     |      | V    |
| I <sub>GSS</sub>     | Gate to Source<br>Reverse Current     | $V_{GS} = -10V, V_{DS} = 0V$                  |       |     | -0.1 | nA   |
| V <sub>GS(OFF)</sub> | Gate to Source<br>Cutoff Voltage      | V <sub>DS</sub> = 10V, I <sub>D</sub> = 0.5nA | -0.35 |     | -2.0 | V    |
| I <sub>DSS</sub>     | Drain to Source<br>Saturation Current | $V_{GS} = 0V, V_{DS} = 10V$ (Pulsed)          | 30    | 300 |      | mA   |

**Dvnamic Characteristics** (@ TA = 25°C, Unless otherwise specified)

|                  | Parameters                                | Conditions  | Min | Тур | Max | Unit   |
|------------------|---|---|-----|-----|-----|--------|
| GFS              | Forward<br>Transconductance               | $V_{DS} = 10V, V_{GS} = 0V, f = 1kHz$                 |     | 750 |     | mS     |
| C <sub>iss</sub> | Input Capacitance                         | V <sub>DS</sub> = 0V, V <sub>GS</sub> = -4V, f = 1MHz |     | 300 |     | рF     |
| Crss             | Reverse Transfer<br>Capacitance           | V <sub>DS</sub> = 0V, V <sub>GS</sub> = -4V, f = 1MHz |     | 200 |     | рF     |
| e <sub>n</sub>   | Equivalent Circuit<br>Input Noise Voltage | V <sub>DS</sub> = 3V, I <sub>D</sub> = 5mA, f = 100Hz |     | 0.5 |     | nV/√Hz |

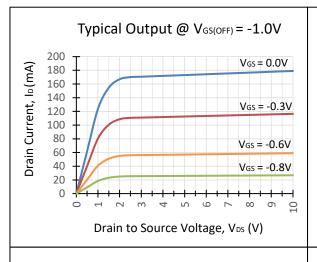


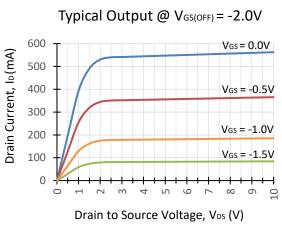


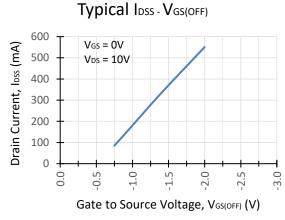


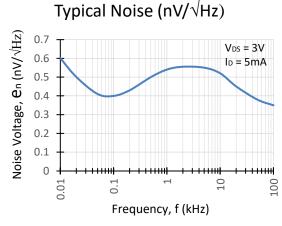


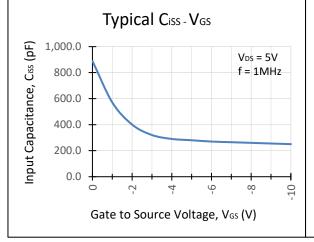
# **Typical IF3601 Characteristics**

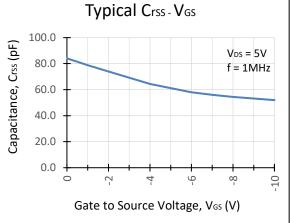














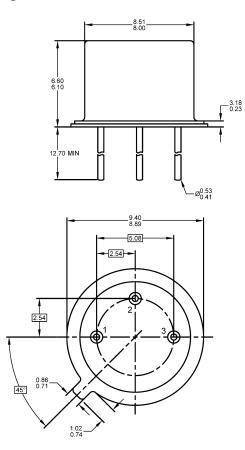






## **TO-39 Mechanical and Layout Data**

## **Package Outline Data**



- **Suggested Through-Hole Layout** 
  - 5.08 -2.54 2.54 2.54 -2.54 -2.54 -2.54 -2.54 -2.54 -2.54

- 1. All linear dimensions are in millimeters.
- 2. Package weight approximately 0.42 grams
- Bulk product is shipped in standard ESD shipping material
- 4. Refer to JEDEC standards for additional information.

- 1. All linear dimensions are in millimeters.
- The suggested land pattern dimensions have been provided as a straight lead reference only. A more robust pattern may be desired for wave soldering and/or bent lead configurations.

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